

<div>SAIESH SASANE</div> <div>Embedded Hardware Engineer</div> <div><div><div><div></div></div><div>Pune, India (Open to Remote)</div></div><div><div><div></div></div><div>+917558512204</div></div><div><div><div></div></div><div>saieshsasane.hireme@gmail.com</div></div><div><div><div></div></div><div>Website</div></div></div>		
Profiles	<div><div></div>saie12</div>	
Summary	Embedded Hardware Engineer specializing in high-speed, 6-layer PCB design. Portfolio includes a Gigabit Ethernet interface (STM32F7+DP83867), IoT home automation (ESP32), and low-power GPS trackers (STM32L4). Proficient in KiCad, controlled impedance routing, power integrity, and firmware development.	
Education	<div><div>K.J.College of Engineering & Management Research, Pune</div><div>Electronics and Communication Engineering - Advanced Communication Technology</div><div>9.1 SGPA</div><div>Relevant Coursework: Microcontrollers, Radiation & Microwave Techniques, Digital Communication, Signals & Systems, Control Systems.</div></div>	<div>August 2023 - May 2027 (Expected)</div> <div>B.Eng.</div>
Projects	<div><div><div>High-Speed Gigabit Ethernet Interface</div><div>August 2025 - November 2025</div></div><div>6-Layer PCB Design for a Gigabit Ethernet Interface (STM32F7 + DP83867)</div><div><div></div>Website</div><div><div><div>Designed a 6-layer, 80x50mm Gigabit Ethernet PCB (STM32F7 + DP83867) with a robust 4-rail power tree (<code>+3.3V</code>, <code>+2.5V</code>, <code>+1.8V</code>, <code>+1.1V</code>).</div><div>Managed full layout in KiCad, including 6-layer stackup, power planes, and manual routing of 100Ω differential & 50Ω single-ended traces.</div><div>Successfully passed all ERC (schematic) and DRC (layout) checks and generated final Gerber/drill files for manufacturing.</div></div><div>KiCad, PCB Design, 6-Layer, High-Speed, RGMII, Gigabit Ethernet, STM32F7, Controlled Impedance, Power Integrity, Gerber</div></div><div><div><div>ESP32 Dual-Relay Smart Switch</div><div>July 2025 - October 2025</div></div><div>Wi-Fi Connected 2-Layer PCB for Controlling High-Voltage AC Loads</div><div><div></div>Website</div><div><div><div>Designed a cost-effective 2-layer PCB integrating an ESP32 module to wirelessly control dual 110V/230V AC mains appliances via electromechanical relays.</div><div>Engineered a safety-critical layout with galvanic isolation, enforcing strict creepage and clearance rules to separate the low-voltage (5V/3.3V) logic from high-voltage AC.</div><div>Implemented transistor-based relay driver circuits and on-board status LEDs for real-time feedback.</div><div>Managed the power distribution network, regulating standard 5V USB input down to a clean 3.3V for stable MCU operation.</div></div><div>ESP32, KiCad, PCB Design, 2-Layer, IoT, Relays, High Voltage, AC/DC Isolation, Safety, Home Automation</div></div><div><div><div>STM32 Cellular GPS Asset Tracker</div><div>August 2025 - October 2025</div></div><div>4-Layer Automotive Tracker with STM32, GNSS, and GSM Connectivity</div><div><div></div>Website</div><div><div><div>Designed a robust 4-layer PCB for real-time asset tracking, integrating an STM32 microcontroller, GPS/GNSS, and GSM/GPRS modules.</div><div>Engineered 50-ohm controlled impedance transmission lines for GPS and GSM antenna signals to maximize RF performance and minimize loss.</div><div>Implemented a wide-input 12V power management system with switching regulators, optimized for direct integration into automotive and industrial environments.</div><div>Managed a mixed-signal stackup with a dedicated solid ground plane to isolate sensitive RF components from digital switching noise.</div></div><div>STM32, KiCad, PCB Design, 4-Layer, RF Design, GSM/GPRS, GNSS, 50-ohm Impedance, Automotive Power, UART</div></div></div></div></div>	
Skills	<div><div><div>Hardware Design & High-Speed</div><div><div></div><div></div><div></div><div></div><div></div></div><div>High-Speed PCB Design (6-Layer), Schematic Capture, Multi-layer PCB Layout, Controlled Impedance Routing, Power Supply Design, Power Integrity, Signal Integrity, Component Selection & Sourcing</div></div><div><div><div>Hardware Tools & Software</div><div><div></div><div></div><div></div><div></div><div></div></div><div>KiCad, ANSYS (Student), SPICE/ngSpice, Git & GitHub, Soldering (SMD & Through-Hole), Oscilloscope, Logic Analyzer</div></div><div><div><div>Programming & Firmware</div><div><div></div><div></div><div></div><div></div><div></div></div><div>C, C++, Python, Bare-Metal Firmware Development, ARM Cortex-M, Makefile & GCC Toolchain</div></div><div><div><div>Platforms & Microcontrollers</div><div><div></div><div></div><div></div><div></div><div></div></div><div>STM32 (F7, L4 Series), ESP32 (Wi-Fi & Bluetooth), GPS Modules (u-blox), LwIP (Lightweight IP Stack), RGMII / RMII Interfaces</div></div><div><div><div>Languages</div><div><div></div><div></div><div></div><div></div><div></div></div><div>English (Professional), Hindi (Fluent), Marathi (Native)</div></div></div></div></div></div></div>	
Certifications	<div><div><div>Robotics Controls Engineering Virtual Experience</div><div>November 2025</div></div><div>Johnson & Johnson (via Forage)</div><div><div></div>View</div><div><div><div>Optimized surgical robotic arm performance</div>by diagnosing control inefficiencies and implementing Python-based PID algorithms.</div><div><div>Validated design modifications</div>through iterative testing and authored a technical proposal for improved system reliability</div></div></div>	